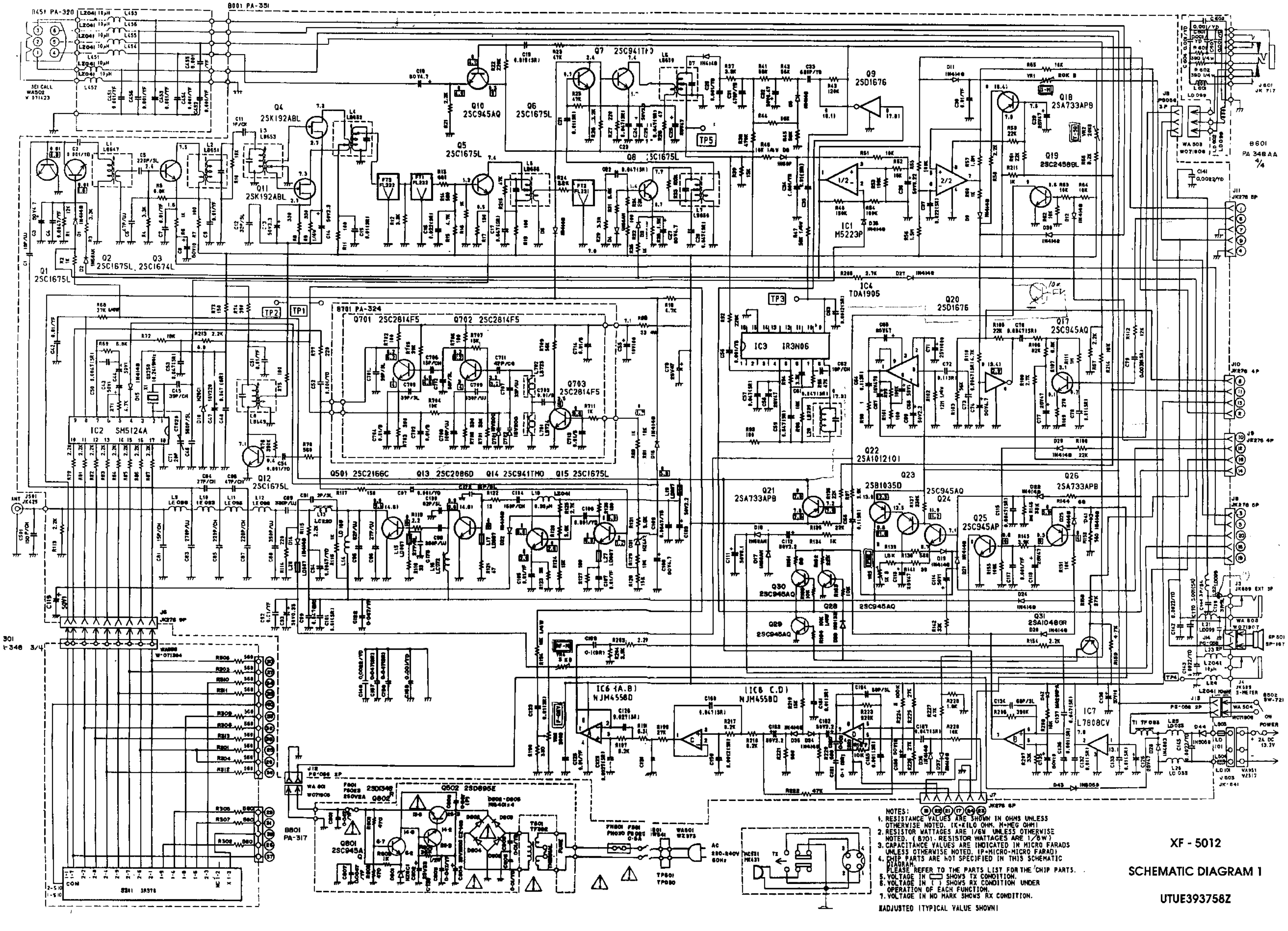


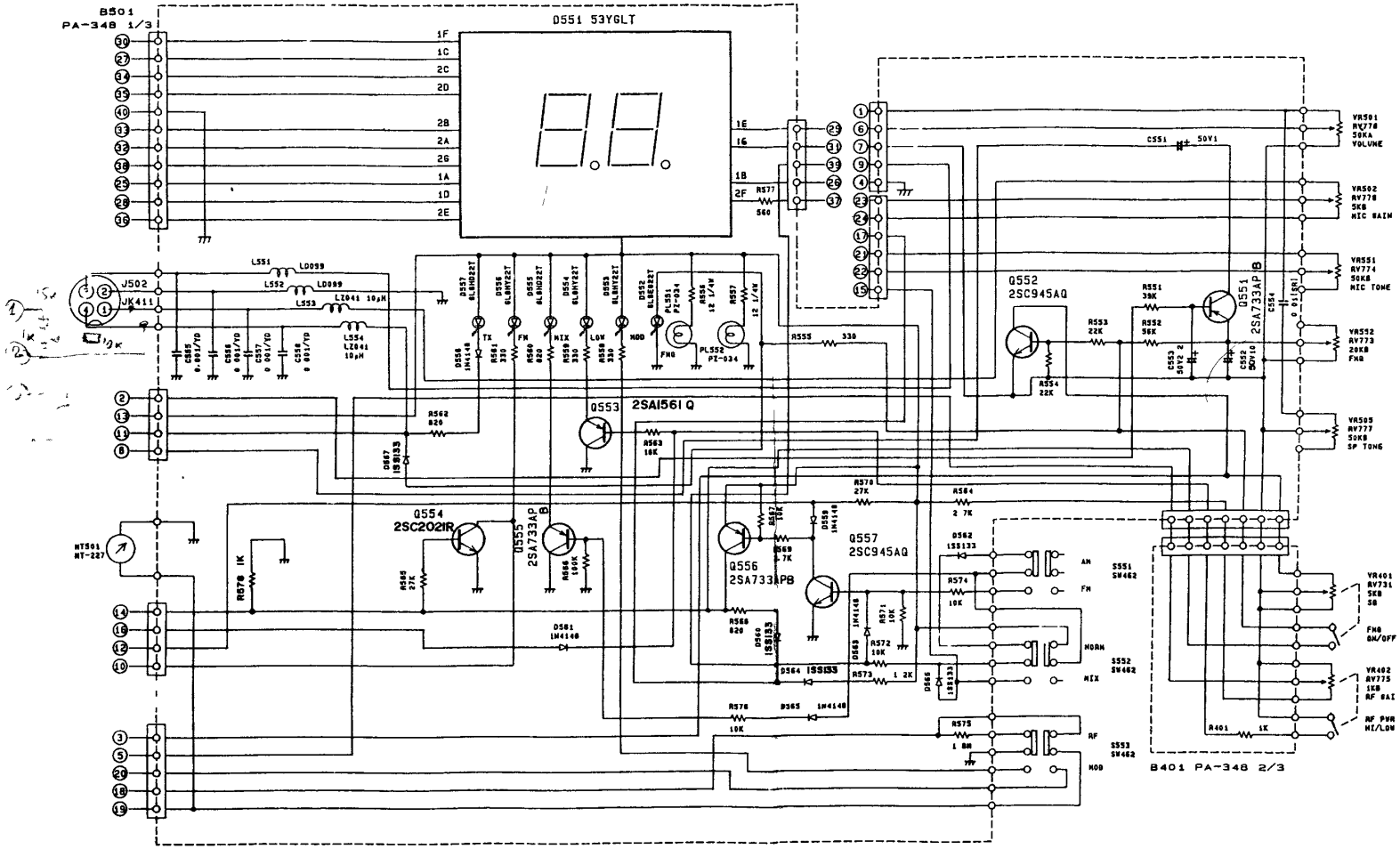

NOTES:
1. RESISTANCE VALUES ARE SHOWN IN OHMS UNLESS OTHERWISE NOTED. (K=KILO OHM, M=MEG OHM)
2. RESISTOR WATTAGES ARE 1/6W UNLESS OTHERWISE NOTED. (B701: RESISTOR WATTAGES ARE 1/8W)
3. CAPACITANCE VALUES ARE INDICATED IN MICRO FARADS UNLESS OTHERWISE NOTED. (P=MICRO-MICRO FARAD)
4. CHIP PARTS ARE NOT SPECIFIED IN THIS SCHEMATIC DIAGRAM. PLEASE REFER TO THE PARTS LIST FOR THE CHIP PARTS.
5. VOLTAGE IN ▭ SHOWS TX CONDITION.
6. VOLTAGE IN ( ) SHOWS RX CONDITION UNDER OPERATION OF EACH FUNCTION.
7. VOLTAGE IN NO MARK SHOWS RX CONDITION.

※ADJUSTED (TYPICAL VALUE SHOWN)

**XF - 5012**

**SCHEMATIC DIAGRAM 1**

**UTUE393758Z**




NOTES:

1. RESISTANCE VALUES ARE SHOWN IN OHMS UNLESS OTHERWISE NOTED.
2. RESISTOR WATTAGES ARE 1/6W UNLESS OTHERWISE NOTED.
3. CAPACITANCE VALUES ARE INDICATED IN MICRO FARADS UNLESS OTHERWISE NOTED. (P=MICRO-MICRO FARAD)
4. ALL CAPACITORS TEMPERATURE CHRACTERISTICS ARE ZF UNLESS OTHERWISE NOTED.
5. ALL CAPACITORS TEMPERATURE CHRACTERISTICS ARE SL (LESS THAN 1000PF) OR ZF (MORE THAN 1000PF) UNLESS OTHERWISE NOTED.

**XF - 5012**

**SCHEMATIC DIAGRAM 2**

**UTUE393759Z**